

M14C16 DD

M14C16 Die Description

PRODUCT

■ WAFER SIZE 152 mm (6 inches)

M14C16

- DIE IDENTIFICATION M14C16KA R
- DIE SIZE (X x Y) 1390 x 2375 µm
- SCRIBE LINE 101.8 x 102.4 µm
- PAD OPENING 100 x 100 µm

DIE LAYOUT

DI Die Identification (at the position shown in Figure 1)
C1, C2, C3, C5, C7 Pad contacts to the ISO pins (at the positions shown in Figure 1)
C4, C6, C8 These ISO pins do not appear on the M14C16 die
NC This pad, shown in Figure 1, is Not Connected

Pad locations are measured relative to the die centre (where X and Y are respectively the horizontal and vertical axis, measured in μ m).

Figure 1. M14C16 Die Plot

C7: SDA (X=-429.0; Y= +	-1004.3)	C5: GND	(X= +337.7; \	Y= +1020.6)
NC: TEST			DI NC: TEST	
			NC: TEST	
			C1: VCC	(X= +514.3; Y= -604.0)
C3: SCL (X= -514.4; Y= -904.4)				
Al02496 C2: WC (X= -349.4; Y= -1004.4)				

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